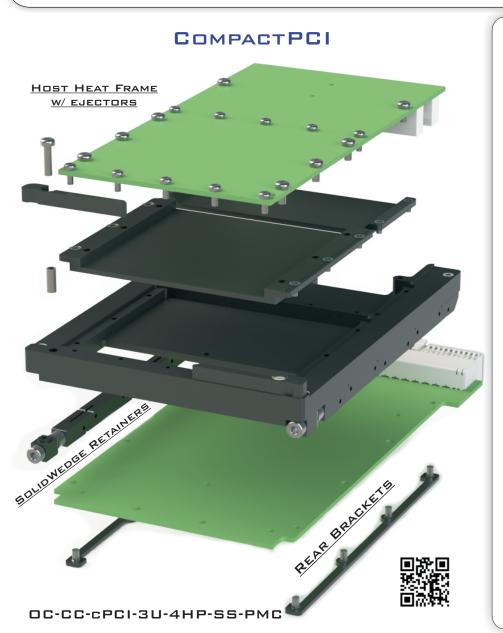
# OpenCOTS 3U CONDUCTION COOLED

OPENCOTS IS A LINE OF STANDARD MECHANICAL AND THERMAL PRODUCTS FROM WAVETHERM FOR VPX AND CPCI APPLICATIONS. THEY ARE INTENDED FOR COMPANIES WHICH BUILD OPEN, MODULAR COMPUTING SOLUTIONS.

WAVETHERM

IN TODAY'S DOD BUDGET REDUCTION ENVIRONMENT, SINGLE-BOARD COMPUTER MANUFACTURERS WHICH RELY ON WAVETHERM CAN IMPROVE THE THERMAL PERFORMANCE OF THEIR EMBEDDED COMPUTERS, SPEND MORE OF THEIR R & D DOLLARS ON RESOURCES FOR THEIR KEY VALUE-ADD, AND BE MORE FLEXIBLE TO THE NEEDS OF THEIR CUSTOMERS.





#### OC-CC-cPCI-3U-4HP-PS-FMC

#### CPCI KIT FEATURES:

- COMPLIES TO CPCI STANDARDS
- CUSTOMIZABLE HEAT PLATES
- INNOVATIVE XMC/PMC HEAT
  PLATES FOR SEC. RAIL MTG

#### STANDARD SETUPS:

- PMC / XMC (REMOVABLE SECONDARY RAILS / FRAMES)
- FMC (REMOVABLE SECONDARY RAILS / FRAMES)
- COM-XPRESS
- FRONT I/O
- SECONDARY SIDE WEDGE LOCKS
- PRIMARY SIDE WEDGE LOCKS
- COMMON PCB LAYOUT FOR AIR-COOLED DESIGNS

#### KIT INCLUDES:

- HOST HEAT FRAME
- SECONDARY SIDE HEAT FRAME
- PMC / XMC HEAT SLUGS
- PAIR OF SOLIDWEDGE CARD
  RETAINERS
- FIELD REPLACEABLE INJECTION / EJECTION HANDLES
- THERMAL INTERFACE MATERIALS
- ASSEMBLY HARDWARE
- 3D MODELS AVAILABLE

#### MATERIALS:

ALUMINUM 6061-T6

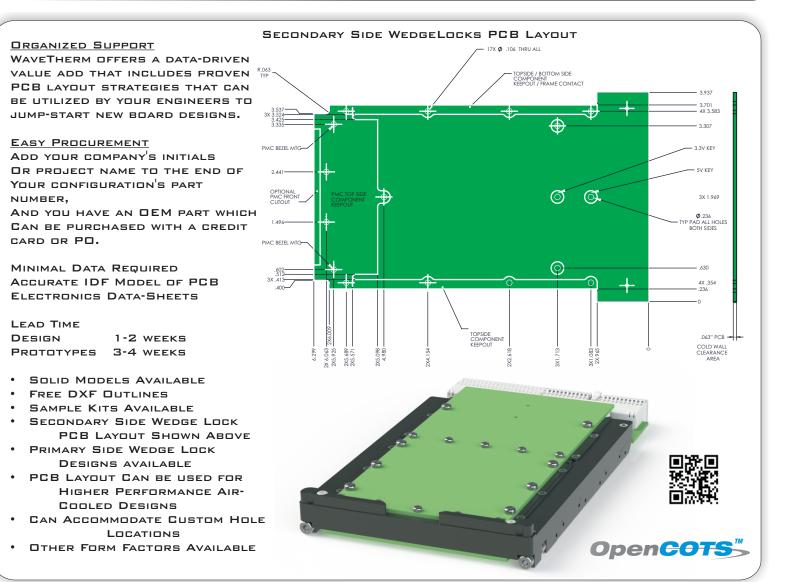
- ALL HEAT FRAMES
- ALL COVERS
- SOLIDWEDGE

OTHER MATERIALS AVAILABLE: COPPER ALUMINUM 6101-T6

RUGGED DESIGN KIT FOR DEVELOPMENT OF 3U CONDUCTION-COOLED CPCI SINGLE BOARD COMPUTERS. STANDARD HEATFRAME COMPONENTS PROVIDED REPRESENT A HIGH PERFORMANCE THERMO-MECHANICAL DESIGN, AND REDUCES ENGINEERING AND FABRICATION COSTS ASSOCIATED WITH CUSTOMIZATION.

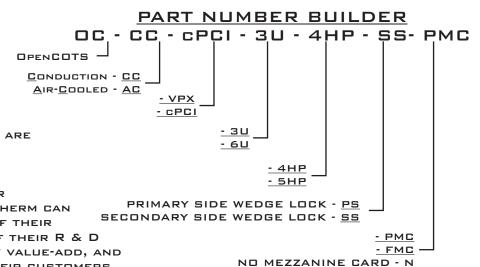
### WAVETHERM C

# OpenCOTS 3U CONDUCTION COOLED



COMPANIES WHICH CHOOSE TO BASE THEIR ELECTRO-MECHANICAL DESIGNS WITHIN OUR PROVEN PCB LAYOUT STRATEGIES CAN ENHANCE THEIR COST COMPETITIVENESS, CONSERVE VALUABLE NRE DOLLARS PER PROJECT, AND ALSO BENEFIT FROM COST SAVINGS ACHIEVED THROUGH ORDERING COMPONENTS THAT ARE MANUFACTURED IN HIGH VOLUME.

IN TODAY'S DOD BUDGET REDUCTION ENVIRONMENT, SINGLE-BOARD COMPUTER MANUFACTURERS WHICH RELY ON WAVETHERM CAN IMPROVE THE THERMAL PERFORMANCE OF THEIR EMBEDDED COMPUTERS, SPEND MORE OF THEIR R & D DOLLARS ON RESOURCES FOR THEIR KEY VALUE-ADD, AND BE MORE FLEXIBLE TO THE NEEDS OF THEIR CUSTOMERS.



### COMPACTPCI